



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Board Level Cooling – Surface Mount 5734



BOARD LEVEL COOLING – Surface Mount 5734

Surface Mount 5734 is a series of surface mount board level heat sinks designed to cool D3 Pak and TO-268 devices. Representative Image Only.



ORDERING INFORMATION

Part Number	Device Type
573400D00000G	D3 Pak/TO-268
573400D00010G	D3 Pak/TO-268

HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Tin Plated
Device Attachment Options	-
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	30.99
Heat Sink Length (mm)	12.70
Heat Sink Height (mm)	10.20
Heat Sink Mounting Direction	Horizontal

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

